# IGBT with Monolithic Free Wheeling Diode

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop (FS) Trench construction, and provides superior performance in demanding switching applications, offering both low on–state voltage and minimal switching loss. The IGBT is well suited for resonant or soft switching applications.

#### Features

- Extremely Efficient Trench with Fieldstop Technology
- 1350 V Breakdown Voltage
- Optimized for Low Losses in IH Cooker Application
- Reliable and Cost Effective Single Die Solution
- These are Pb-Free Devices

#### **Typical Applications**

- Inductive Heating
- Consumer Appliances
- Soft Switching

#### **ABSOLUTE MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector-emitter voltage	V <sub>CES</sub>	1350	V
Collector current @ Tc = 25°C @ Tc = 100°C	Ι <sub>c</sub>	80 40	A
Pulsed collector current, $T_{pulse}$ limited by $T_{Jmax}$ , 10 $\mu$ s Pulse, $V_{GE}$ = 15 V	I <sub>CM</sub>	120	A
Diode forward current @ Tc = 25°C @ Tc = 100°C	I <sub>F</sub>	80 40	A
Diode pulsed current, $T_{pulse}$ limited by $T_{Jmax}$ , 10 $\mu$ s Pulse, $V_{GE}$ = 0 V	I <sub>FM</sub>	120	A
Gate-emitter voltage Transient Gate-emitter Voltage (T <sub>pulse</sub> = 5 µs, D < 0.10)	$V_{GE}$	±20 ±25	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P <sub>D</sub>	394 197	W
Operating junction temperature range	ТJ	-40 to +175	°C
Storage temperature range	T <sub>stg</sub>	–55 to +175	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T <sub>SLD</sub>	260	°C

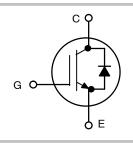
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

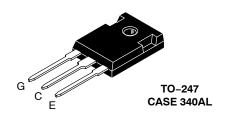


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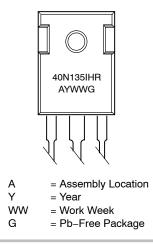
http://onsemi.com

40 A, 1350 V V<sub>CEsat</sub> = 2.40 V E<sub>off</sub> = 1.30 mJ





#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

Device	Package	Shipping
NGTB40N135IHRWG	TO–247 (Pb–Free)	30 Units / Rail

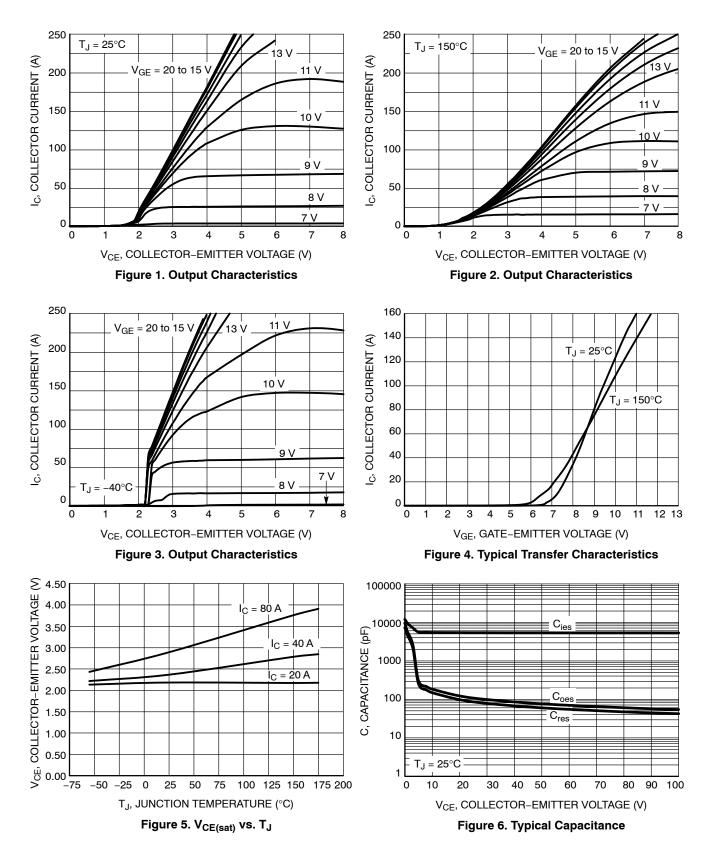
#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case	$R_{ ext{ heta}JC}$	0.385	°C/W
Thermal resistance junction-to-ambient	$R_{\theta JA}$	40	°C/W

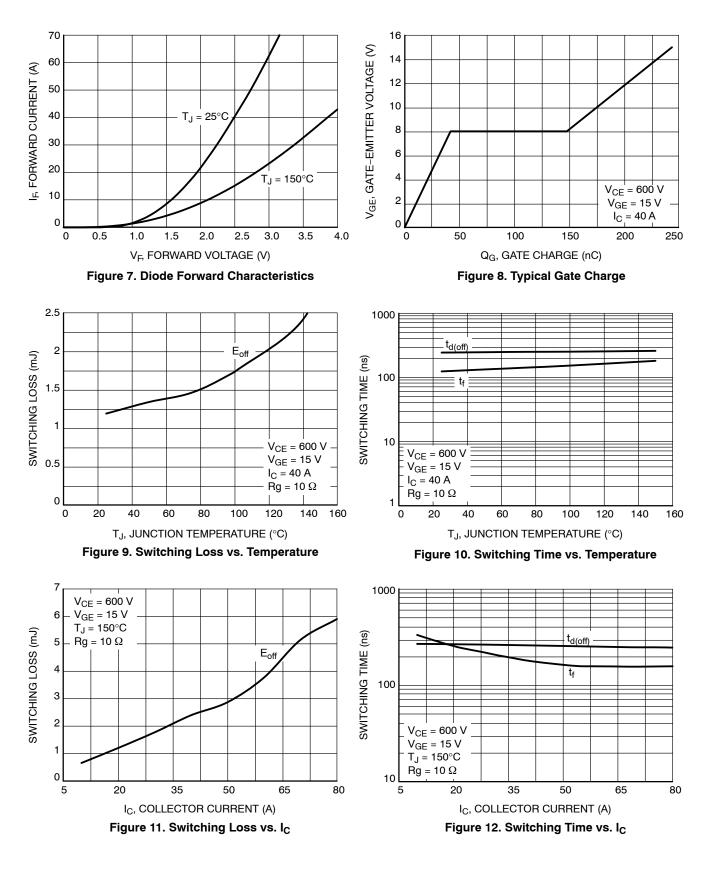
#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC	•	•			•	
Collector-emitter breakdown voltage, gate-emitter short-circuited	$V_{GE}$ = 0 V, I <sub>C</sub> = 500 $\mu$ A	V <sub>(BR)CES</sub>	1350	_	_	V
Collector-emitter saturation voltage	$V_{GE}$ = 15 V, I <sub>C</sub> = 40 A V <sub>GE</sub> = 15 V, I <sub>C</sub> = 40 A, T <sub>J</sub> = 175°C	V <sub>CEsat</sub>		2.40 2.80	2.70 -	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}$ , $I_C = 250 \ \mu A$	V <sub>GE(th)</sub>	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE}$ = 0 V, $V_{CE}$ = 1350 V $V_{GE}$ = 0 V, $V_{CE}$ = 1350 V, $T_{J}$ = 175°C	I <sub>CES</sub>			0.5 2.0	mA
Gate leakage current, collector-emitter short-circuited	$V_{GE}$ = 20 V, $V_{CE}$ = 0 V	I <sub>GES</sub>	_	-	100	nA
DYNAMIC CHARACTERISTIC						
Input capacitance	V <sub>CE</sub> = 20 V, V <sub>GE</sub> = 0 V, f = 1 MHz	C <sub>ies</sub>	-	5290	_	pF
Output capacitance		C <sub>oes</sub>	-	124	-	
Reverse transfer capacitance		C <sub>res</sub>	-	100	-	
Gate charge total		Qg	-	234	-	nC
Gate to emitter charge	$V_{CE}$ = 600 V, I <sub>C</sub> = 40 A, V <sub>GE</sub> = 15 V	Q <sub>ge</sub>	-	39	-	
Gate to collector charge		Q <sub>gc</sub>	-	105	-	
SWITCHING CHARACTERISTIC, INDUCT	IVE LOAD					
Turn-off delay time	$T_J = 25^{\circ}C$	t <sub>d(off)</sub>	-	250	-	ns
Fall time	V <sub>CC</sub> = 600 V, I <sub>C</sub> = 40 A R <sub>g</sub> = 10 Ω V <sub>GE</sub> = 0 V/ 15 V	t <sub>f</sub>	-	130	-	
Turn-off switching loss		E <sub>off</sub>	-	1.30	-	mJ
Turn-off delay time	T <sub>J</sub> = 150°C	t <sub>d(off)</sub>	-	260	-	ns
Fall time	V <sub>CC</sub> = 600 V, I <sub>C</sub> = 40 A R <sub>g</sub> = 10 Ω V <sub>GE</sub> = 0 V/ 15 V	t <sub>f</sub>	-	190	-	
Turn-off switching loss		E <sub>off</sub>	-	2.60	-	mJ
DIODE CHARACTERISTIC						
Forward voltage	V <sub>GE</sub> = 0 V, I <sub>F</sub> = 40 A V <sub>GE</sub> = 0 V, I <sub>F</sub> = 40 A, T <sub>J</sub> = 175°C	V <sub>F</sub>	-	2.30 3.70	2.70 -	V

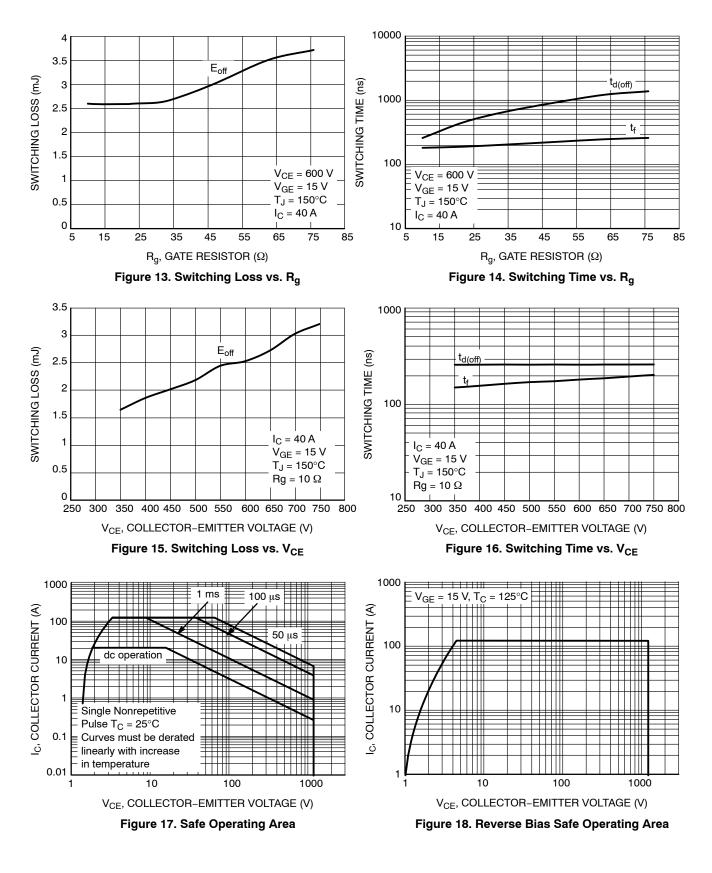
### **TYPICAL CHARACTERISTICS**



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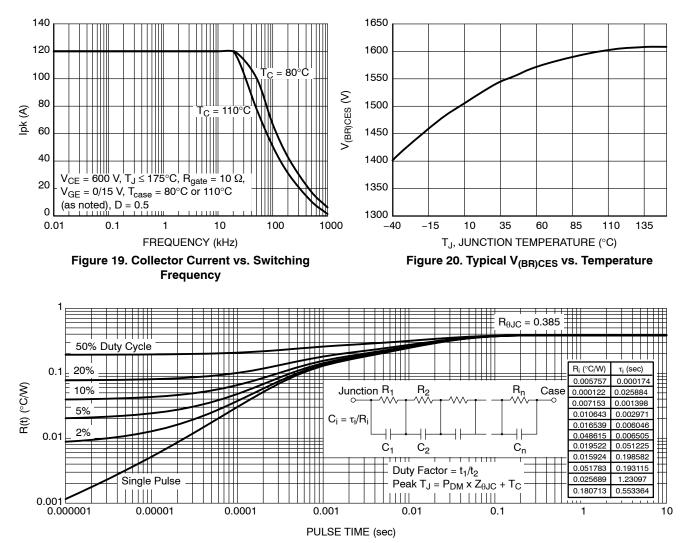


Figure 21. IGBT Transient Thermal Impedance

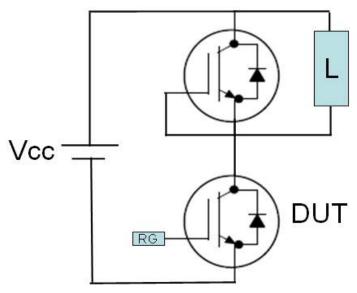
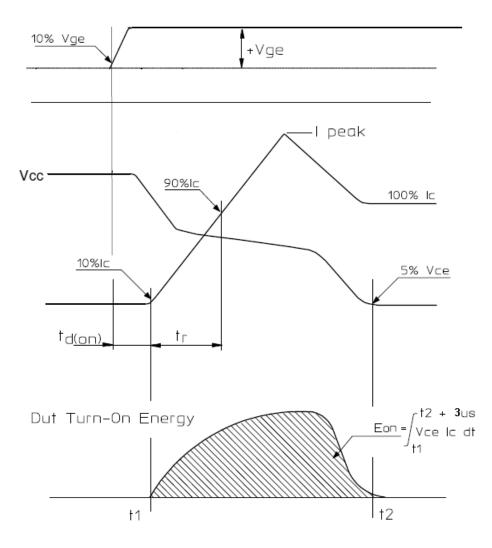
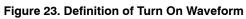


Figure 22. Test Circuit for Switching Characteristics





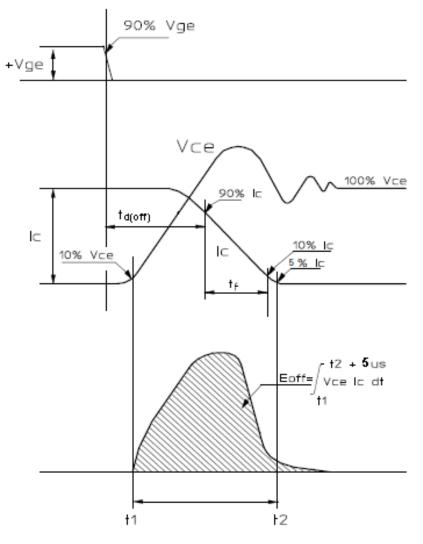
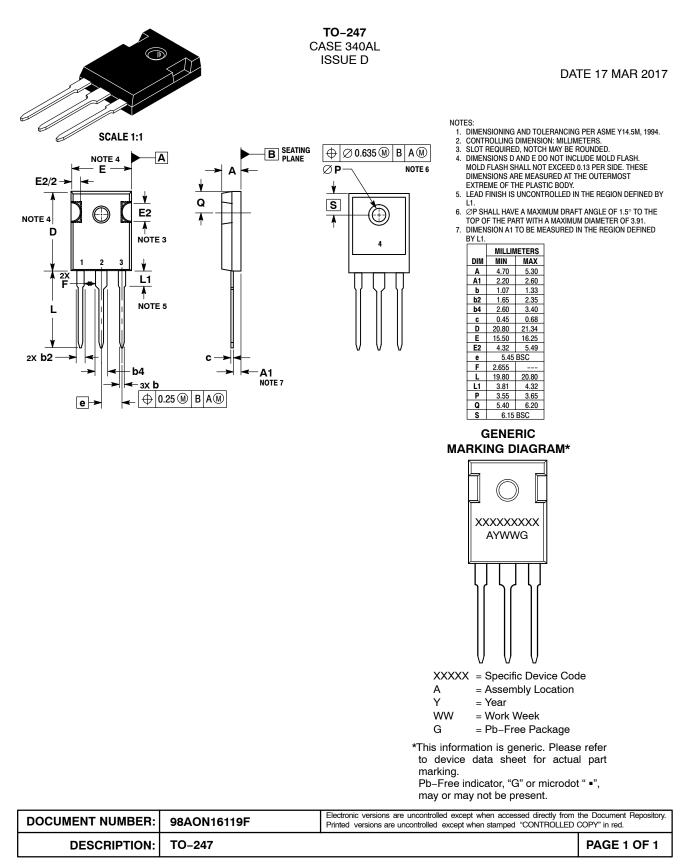


Figure 24. Definition of Turn Off Waveform

# **MECHANICAL CASE OUTLINE**

PACKAGE DIMENSIONS





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